



Applicant: Romain L. Billiet et al.

Title: ULTRASMALL SEMICONDUCTOR BONDING TOOLS

AND METHOD OF FABRICATION THEREOF

Appl. No.: 10/082,867

Filing Date: February 18, 2002

Examiner: Christopher A. Fiorilla

Art Unit: 1731

RESPONSE

Mail Stop NON-FEE AMENDMENT Commissioner for Patents PO Box 1450 Alexandria, Virginia 22313-1450

Sir:

This paper is in response to the Office Action dated February 03, 2004.

Amendment to the claims begin on page 2 of this document.

Amendments to the specification begin on page 6 of this document.

Remarks begin on page 7 of this document.